

PRODUCTS

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# SPMZ2001GST1 :Part Detail

APPLICATIONS

SUPPORT

ABOUT

General Information	Package Information Environmenta	al an	d Compliance Information	Manufacturing Information	Ordering Information
	Product/Process Change Notice (PC	۷)	Operating Characteristics	Reliability Data Lookup	

#### **General Information**

Part Number	SPMZ2001GST1
Description	COMPENSATED MINI-PAK
Product Line	XM2001GS
PTI	AKPF
Material Type	Tested Packaged Device
Life Cycle Description (code)	PRODUCT MATURITY/SATURATION
Status	Active
Application/Qualification Tier	10-YEARS APPLICATION LIFE

#### **Package Information**

Package Type and Termination Count	Sensor 5
Package Description and Mechanical Drawing	SNSR M-PAK 05 PORTED
Device Weight(g)	0.54330
Package Material	Plastic
Mounting Style	Surface Mount
Package Length (nominal)(mm)	0.370
Package Width (nominal)(mm)	0.290
Package Thickness (nominal)(mm)	4.830
Tape & Reel	Yes

#### **Environmental and Compliance Information**

Pb-Free	е
RoHS Compliant	√RoHS
Material Composition Declaration (MCD)	Download MCD Report 🔁 Download MCD Report 🛅
RoHS Certificate of Analysis (CoA)	Contact Us
2nd Level Interconnect	Contact Us
Peak Package Body Temperature (PPT)(°C)	250
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Maximum Time at Peak Temperature (s)	30
Number of Reflow Cycles	3
REACH SVHC	NXP REACH Statement

## Manufacturing Information

Micron Size(µm)	6
	0

## **Ordering Information**

Minimum Package Quantity (MPQ)	400
MPQ Container	REEL
Exempt from Minimum Delivery Value	No
Preferred Order Quantity (POQ)	800
POQ Container	BOX
Export Control Classification Number (US)	EAR99
Harmonized Tariff (	
CCATS Document	-
ENC Status	-
Other Trade Compliance Documents	-
Budgetary Price excluding tax(US Currency	-
Order	

Product/Process Change Notice (PCN)

Number	Туре	Title	Issue Date	Effectivity Date
14572A	Update Notification	NEW PREMOLDED LEADFRAME SUPPLIER	19 Dec 201113 Jun 2	2012
14572	Product Change Notice	NEW PREMOLDED LEADFRAME SUPPLIER	10 Oct 2011 07 Apr 2	2012
14266	Product Change Notice	PRESSURE SENSORS SIFEL GEL CONVERSION - UNCOMPENSATED, COMPENSATED AND INTEGRATED	14 Apr 2011 11 Oct 2	2011
P14572	Product Alert	NEW PREMOLDED LEADFRAME SUPPLIER FOR PRESSURE SENSOR PRODUCTS	12 Apr 2011 12 Apr 2	2011
P14266	Product Alert	PRESSURE SENSORS SIFEL GEL CONVERSION - UNCOMPENSATED, COMPENSATED AND INTEGRATED PRESSURE SENSOR 100MM	09 Jul 2010 09 Jul 2	010
13871 Downloaded from Arrow.com.	Product Change	TO 150MM WAFER LINE CONVERSION - UNCOMPENSATED AND	29 Sep 200930 Dec	2009

		COMPENSATED PRESSURE SENSOR 100MM		
P13168	Product Alert	TO 150MM WAFER LINE CONVERSION	26 Feb 200826 Feb 20	008
<b>Operating Characteristics</b>				
Sample Exception Availability	Ν			
Reliability Data Lookup				
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